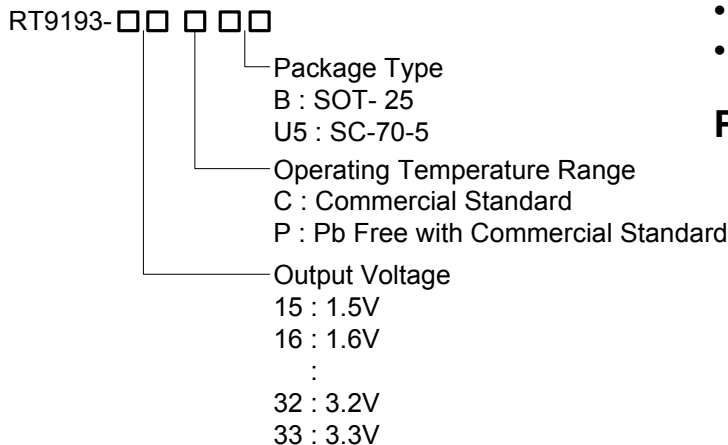


300mA, Ultra-Low Noise, Ultra-Fast CMOS LDO Regulator

General Description

The RT9193 is designed for portable RF and wireless applications with demanding performance and space requirements. The RT9193 performance is optimized for battery-powered systems to deliver ultra low noise and low quiescent current. A noise bypass pin is available for further reduction of output noise. Regulator ground current increases only slightly in dropout, further prolonging the battery life. The RT9193 also works with low-ESR ceramic capacitors, reducing the amount of board space necessary for power applications, critical in hand-held wireless devices. The RT9193 consumes less than 0.01 μ A in shutdown mode and has fast turn-on time less than 50 μ s. The other features include ultra low dropout voltage, high output accuracy, current limiting protection, and high ripple rejection ratio. Available in the 5-lead SOT-25 and SC-70 packages, the RT9193 also offers a range of 1.5V to 3.3V with 0.1V per step.

Ordering Information



Marking Information

For marking information, contact our sales representative directly or through a RichTek distributor located in your area, otherwise visit our website for detail.

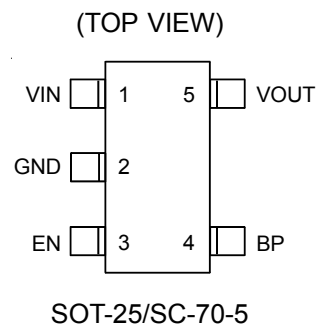
Features

- Ultra-Low-Noise for RF Application
- Ultra-Fast Response in Line/Load Transient
- Quick Start-Up (Typically 50 μ s)
- < 0.01 μ A Standby Current When Shutdown
- Low Dropout : 220mV @ 300mA
- Wide Operating Voltage Ranges : 2.5V to 5.5V
- TTL-Logic-Controlled Shutdown Input
- Low Temperature Coefficient
- Current Limiting Protection
- Thermal Shutdown Protection
- Only 1 μ F Output Capacitor Required for Stability
- High Power Supply Rejection Ratio
- Custom Voltage Available

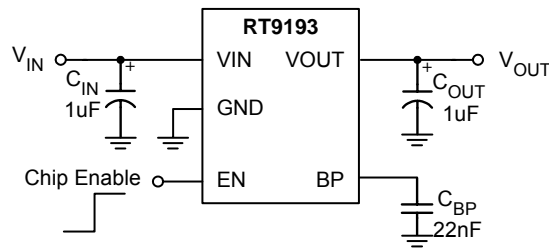
Applications

- CDMA/GSM Cellular Handsets
- Battery-Powered Equipment
- Laptop, Palmtops, Notebook Computers
- Hand-Held Instruments
- PCMCIA Cards
- Portable Information Appliances

Pin Configurations



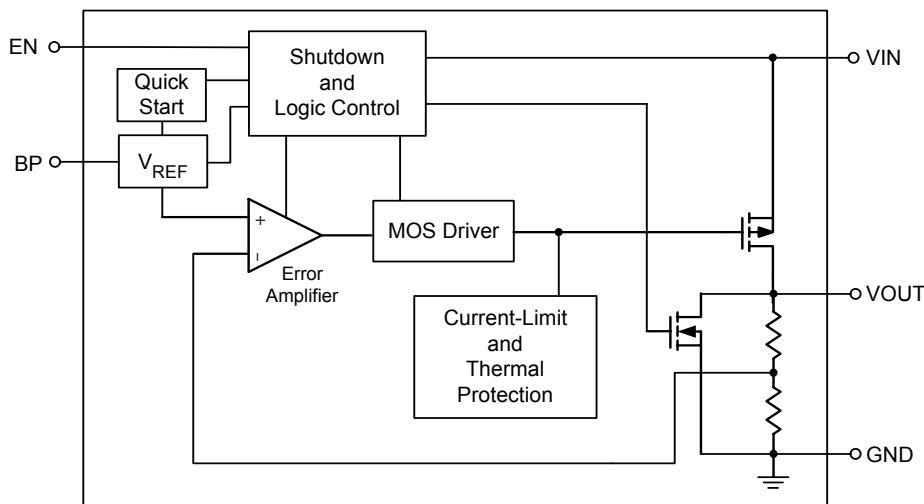
Typical Application Circuit



Functional Pin Description

Pin Number	Pin Name	Pin Function
1	VIN	Power Input Voltage
2	GND	Ground
3	EN	Chip Enable (Active High)
4	BP	Reference Noise Bypass
5	VOUT	Output Voltage

Function Block Diagram



Absolute Maximum Ratings (Note 1)

- Supply Input Voltage ----- 6V
- Power Dissipation, P_D @ $T_A = 25^\circ\text{C}$
 - SC-70-5 ----- 0.3W
 - SOT-25 ----- 0.4W
- Package Thermal Resistance (Note 4)
 - SOT-70-5, θ_{JA} ----- 333°C/W
 - SOT-25, θ_{JA} ----- 250°C/W
- Lead Temperature (Soldering, 10 sec.) ----- 260°C
- Storage Temperature Range ----- -65°C to 150°C
- Operation Temperature Range ----- -40°C to 85°C
- ESD Susceptibility (Note 2)
 - HBM (Human Body Mode) ----- 2kV
 - MM (Machine Mode) ----- 200V

Recommended Operating Conditions (Note 3)

- Supply Input Voltage ----- 2.5V to 5.5V

Electrical Characteristics

($V_{IN} = V_{OUT} + 1V$, $C_{IN} = C_{OUT} = 1\mu\text{F}$, $C_{BP} = 10\text{nF}$, $T_A = 25^\circ\text{C}$, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units	
Output Voltage Accuracy	ΔV_{OUT}	$I_{OUT} = 1\text{mA}$	-2	--	+2	%	
Current Limit	I_{LIM}	$R_{LOAD} = 1\Omega$	360	400	--	mA	
Quiescent Current	I_Q	$V_{EN} \geq 1.2V$, $I_{OUT} = 0\text{mA}$	--	90	130	μA	
Dropout Voltage (Note 5)	V_{DROP}	$I_{OUT} = 200\text{mA}$		170	200	mV	
		$I_{OUT} = 300\text{mA}$	--	220	300		
Line Regulation	ΔV_{LINE}	$V_{IN} = (V_{OUT} + 0.3V)$ to 5.5V, $I_{OUT} = 1\text{mA}$	--	--	0.3	%	
Load Regulation	ΔV_{LOAD}	$1\text{mA} < I_{OUT} < 300\text{mA}$	--	--	0.6	%	
Standby Current	I_{STBY}	$V_{EN} = \text{GND}$, Shutdown	--	0.01	1	μA	
EN Input Bias Current	I_{IBSD}	$V_{EN} = \text{GND}$ or V_{IN}	--	0	100	nA	
EN Threshold	Logic-Low Voltage	V_{IL}	$V_{IN} = 3V$ to 5.5V, Shutdown	--	--	0.4	V
	Logic-High Voltage	V_{IH}	$V_{IN} = 3V$ to 5.5V, Start-Up	1.2	--	--	
Output Noise Voltage	e_{NO}	10Hz to 100kHz, $I_{OUT} = 200\text{mA}$ $C_{OUT} = 1\mu\text{F}$	--	100	--	μV_{RMS}	
Power Supply Rejection Rate	f = 100Hz	PSRR	$C_{OUT} = 1\mu\text{F}$, $I_{OUT} = 10\text{mA}$	--	-70	--	dB
	f = 10kHz			--	-72	--	
Thermal Shutdown Temperature	T_{SD}		--	165	--	$^\circ\text{C}$	
Thermal Shutdown Temperature Hysteresis	ΔT_{SD}		--	30	--	$^\circ\text{C}$	

Note 1. Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

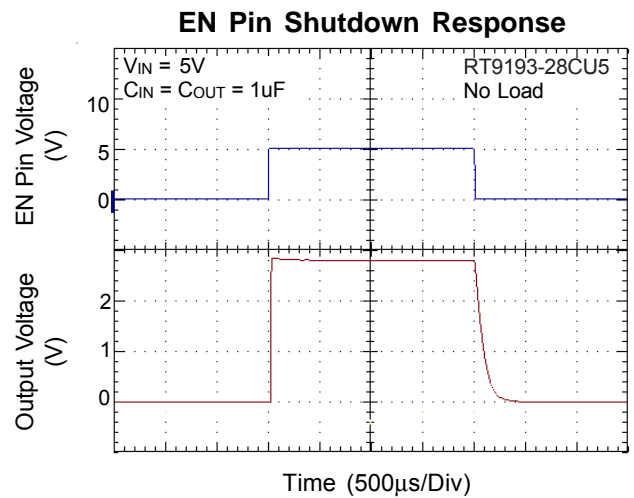
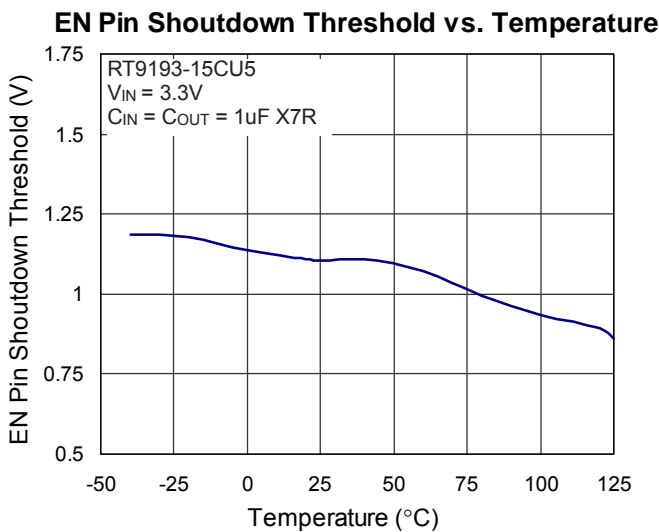
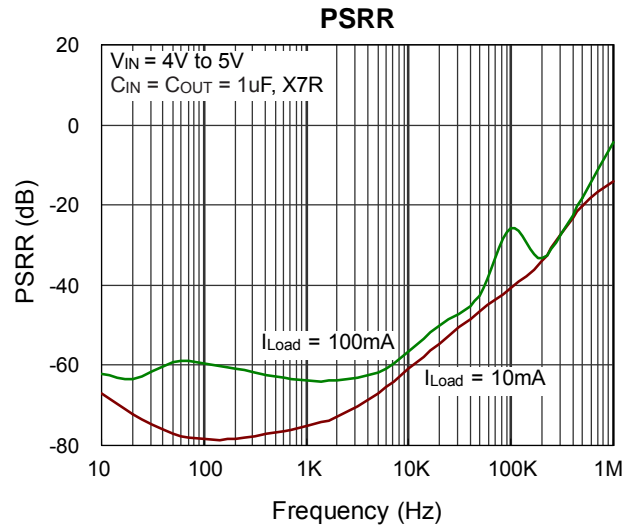
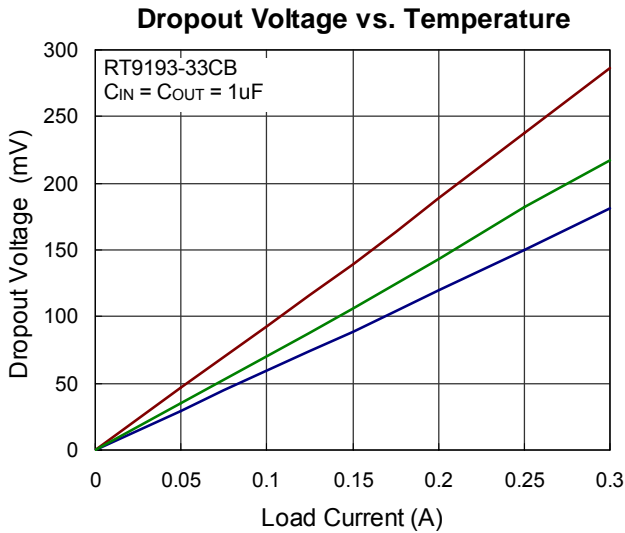
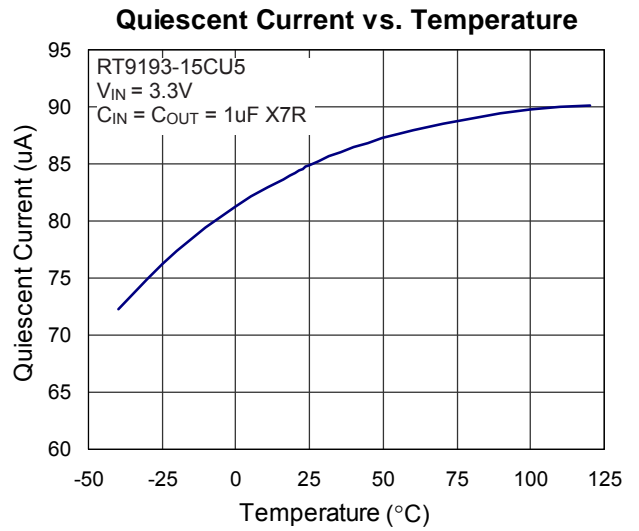
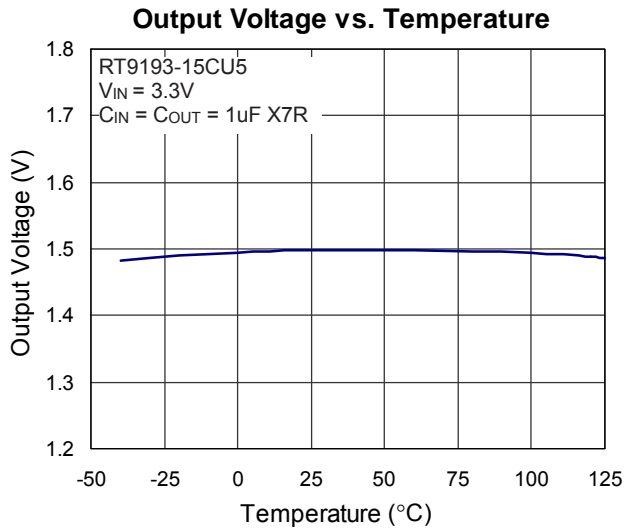
Note 2. Devices are ESD sensitive. Handling precaution recommended.

Note 3. The device is not guaranteed to function outside its operating conditions.

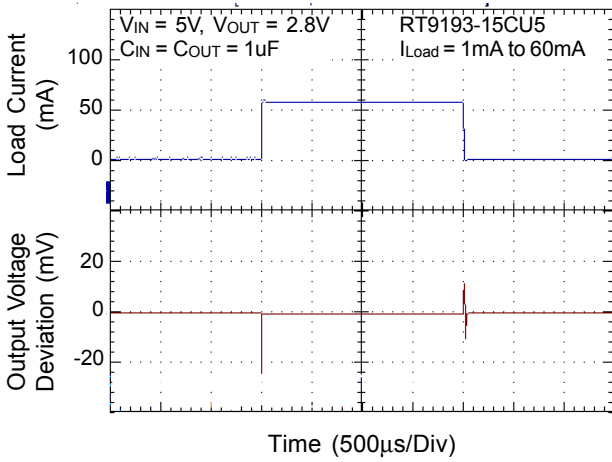
Note 4. θ_{JA} is measured in the natural convection at $T_A = 25^\circ\text{C}$ on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

Note 5. The dropout voltage is defined as $V_{IN} - V_{OUT}$, which is measured when V_{OUT} is $V_{OUT(NORMAL)} - 100\text{mV}$.

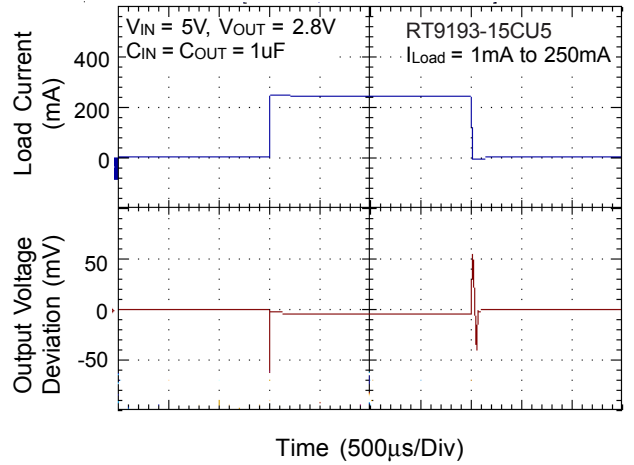
Typical Operating Characteristics



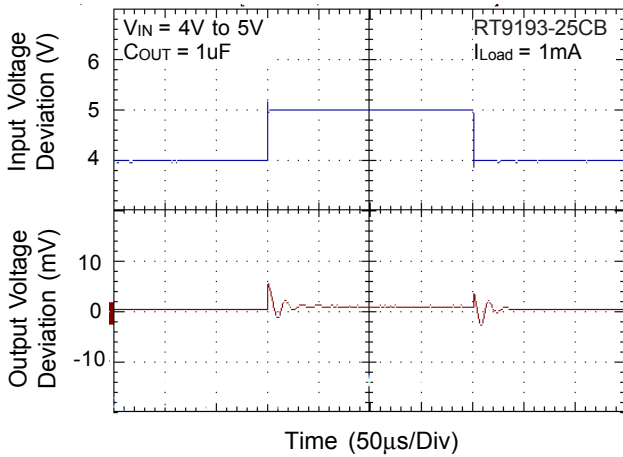
Load Transient Response



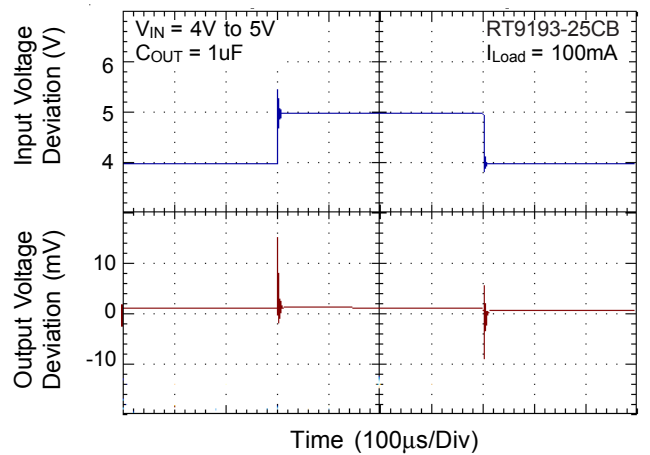
Load Transient Response



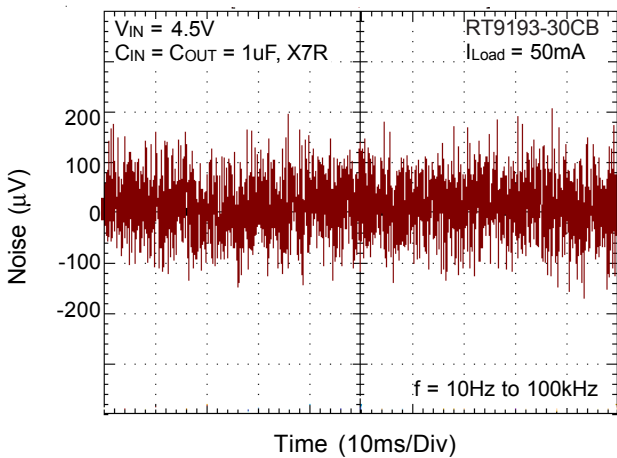
Line Transient Response



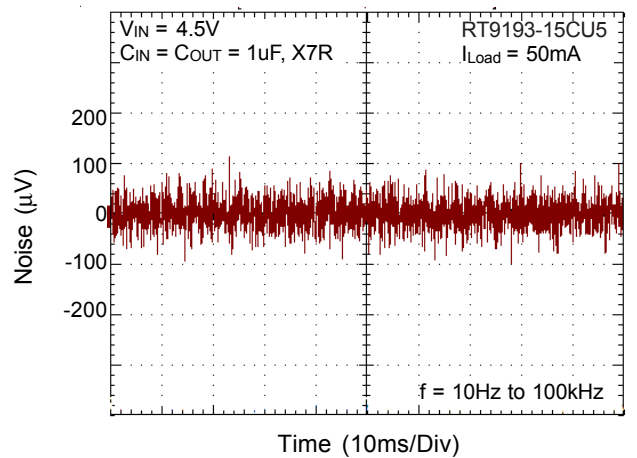
Line Transient Response

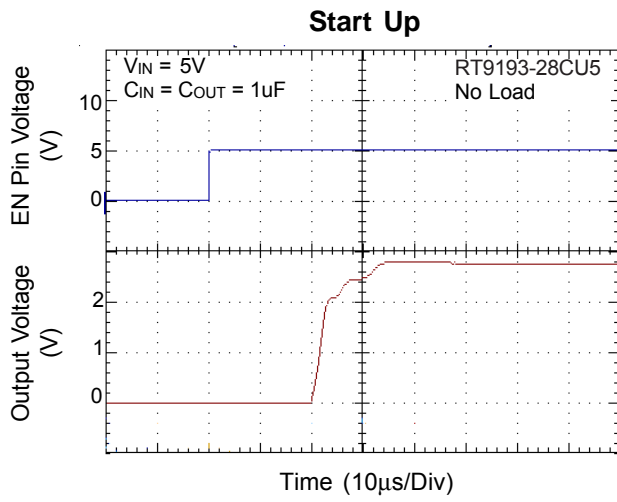


Noise



Noise





Applications Information

Like any low-dropout regulator, the external capacitors used with the RT9193 must be carefully selected for regulator stability and performance. Using a capacitor whose value is $> 1\mu\text{F}$ on the RT9193 input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response. The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The RT9193 is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least $1\mu\text{F}$ with ESR is $> 25\text{m}\Omega$ on the RT9193 output ensures stability. The RT9193 still works well with output capacitor of other types due to the wide stable ESR range. Figure 1 shows the curves of allowable ESR range as a function of load current for various output capacitor values. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the V_{OUT} pin of the RT9193 and returned to a clean analog ground.

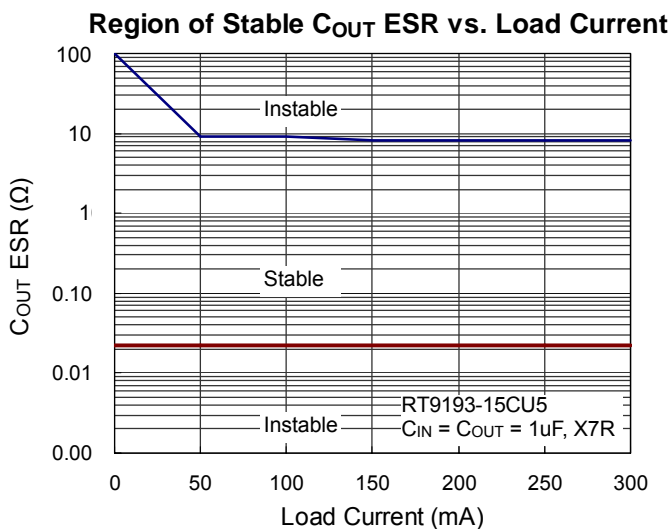


Figure 1

Bypass Capacitor and Low Noise

Connecting a 22nF between the BP pin and GND pin significantly reduces noise on the regulator output, it is critical that the capacitor connection between the BP pin and GND pin be direct and PCB traces should be as short as possible. There is a relationship between the bypass capacitor value and the LDO regulator turn on time. DC leakage on this pin can affect the LDO regulator output noise and voltage regulation performance.

Enable Function

The RT9193 features an LDO regulator enable/disable function. To assure the LDO regulator will switch on, the EN turn on control level must be greater than 1.2 volts. The LDO regulator will go into the shutdown mode when the voltage on the EN pin falls below 0.4 volts. For protecting the system, the RT9193 have a quick-discharge function. If the enable function is not needed in a specific application, it may be tied to V_{IN} to keep the LDO regulator in a continuously on state.

Thermal Considerations

Thermal protection limits power dissipation in RT9193. When the operation junction temperature exceeds 165°C , the OTP circuit starts the thermal shutdown function turn the pass element off. The pass element turn on again after the junction temperature cools by 30°C .

For continue operation, do not exceed absolute maximum operation junction temperature 125°C . The power dissipation definition in device is:

$$P_D = (V_{\text{IN}} - V_{\text{OUT}}) \times I_{\text{OUT}} + V_{\text{IN}} \times I_Q$$

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula:

$$P_{D(\text{MAX})} = (T_{J(\text{MAX})} - T_A) / \theta_{JA}$$

Where $T_{J(\text{MAX})}$ is the maximum operation junction temperature 125°C , T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

For recommended operating conditions specification of RT9193, where $T_{J(MAX)}$ is the maximum junction temperature of the die (125°C) and T_A is the maximum ambient temperature. The junction to ambient thermal resistance (θ_{JA} is layout dependent) for SOT-25 package is 250°C/W and SC-70-5 package is 333°C/W on standard JEDEC 51-3 thermal test board. The maximum power dissipation at $T_A = 25^\circ\text{C}$ can be calculated by following formula:

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / 250 = 400\text{mW (SOT-25)}$$

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / 333 = 300\text{mW (SC-70-5)}$$

The maximum power dissipation depends on operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance θ_{JA} . For RT9193 packages, the Figure 2 of derating curves allows the designer to see the effect of rising ambient temperature on the maximum power allowed.

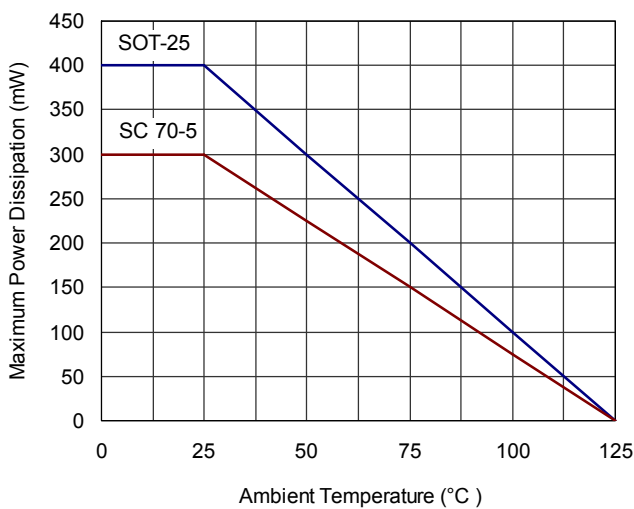
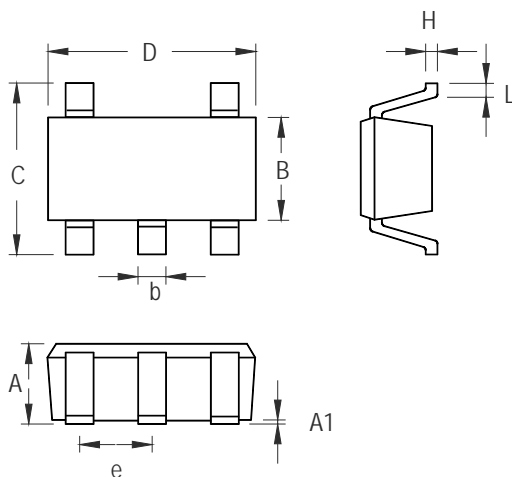


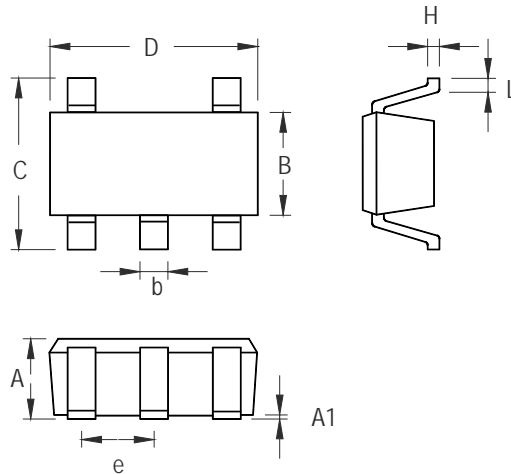
Figure 2. Derating Curve for Packages

Outline Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.100	0.031	0.044
A1	0.000	0.100	0.000	0.004
B	1.150	1.350	0.045	0.054
b	0.150	0.400	0.006	0.016
C	1.800	2.450	0.071	0.096
D	1.800	2.250	0.071	0.089
e	0.650		0.026	
H	0.080	0.260	0.003	0.010
L	0.210	0.460	0.008	0.018

SC-70-5 Surface Mount Package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
B	1.397	1.803	0.055	0.071
b	0.356	0.559	0.014	0.022
C	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
e	0.838	1.041	0.033	0.041
H	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SOT- 25 Surface Mount Package

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